

N-Channel 200 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	_S (V) $R_{DS(on)}$ (Ω) I_D (A)					
200	0.010 at V _{GS} = 10 V	160				

FEATURES

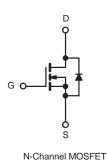
- DT-Trench Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R_g Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch

0	
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G D S Top View	

TO-220AB



ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	200	V	
Gate-Source Voltage	V _{GS}	± 20	V		
Orationary Drain Oranget (T. 175 00)b	T _C = 25 °C	1	160		
Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^{b}$	T _C = 100 °C	I _D	100		
Pulsed Drain Current	I _{DM}	430	А		
Continuous Source Current (Diode Conduction)	I _S	160			
Avalanche Current	I _{AS}	88	1		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	386	mJ	
Maximum Power Dissipation	T _C = 25 °C	P _D	416 ^b	w	
Maximum rower dissipation	T _C = 100 °C	U .	131 ^a	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
hursting to Ambiguid	$t \le 10 \text{ s}$	R _{thJA}		15	°C/W	
Junction-to-Ambient ^a	Steady State			46		
Junction-to-Case (Drain)		R _{thJC}		1.0		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.



Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static	•	·		•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	200			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	I _{DSS}	$\frac{V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}}{V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}}$			1		
Zero Gate Voltage Drain Current				50	μA		
		$V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250	1	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	160			А	
		V _{GS} = 10 V, I _D = 20 A	A 0.01 0.014		0.014		
Drain Course On Chata Daviston ash	Real	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C			0.015	0	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V_{GS} = 10 V, I _D = 20 A, T _J = 175 °C			0.019	Ω	
		V _{GS} = 6 V, I _D = 20 A		0.015	0.018		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		56		S	
Dynamic ^a							
Input Capacitance	C _{iss}			9800		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 100 V, F = 1 MHz		1060			
Reverse Transfer Capacitance	C _{rss}			560			
Total Gate Charge ^c	Qg			44			
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 20 A		18		nC	
Gate-Drain Charge ^c	Q _{gd}			12			
Gate Resistance	Rg		0.5		2.9	Ω	
Turn-On Delay Time ^c	t _{d(on)}			19			
Rise Time ^c	tr	V_{DD} = 100 V, R _L = 5.2 Ω		25		20	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 20 A, V_GEN = 10 V, R_g = 2.5 Ω		30		ns	
Fall Time ^c	t _f			10			
Source-Drain Diode Ratings and Char	acteristics (1	Γ _C = 25 °C)					
Pulsed Current	I _{SM}				430	А	
Diode Forward Voltage ^b	V _{SD}	I _F = 20 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 19 A, dl/dt = 100 A/μs		80		ns	

Notes:

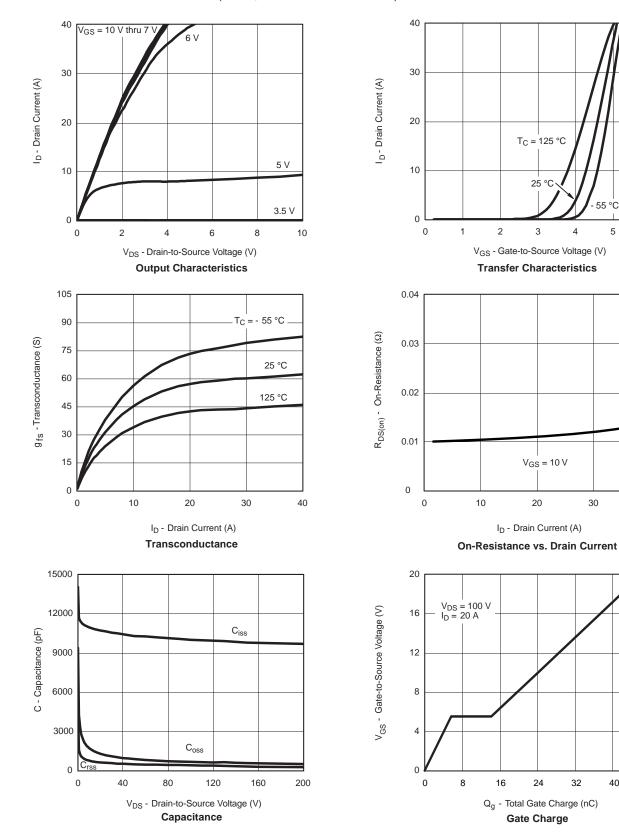
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



55 °C



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

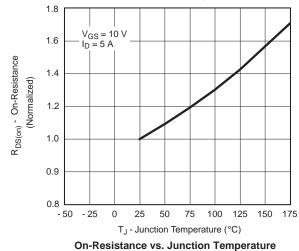


T_J = 25 °C

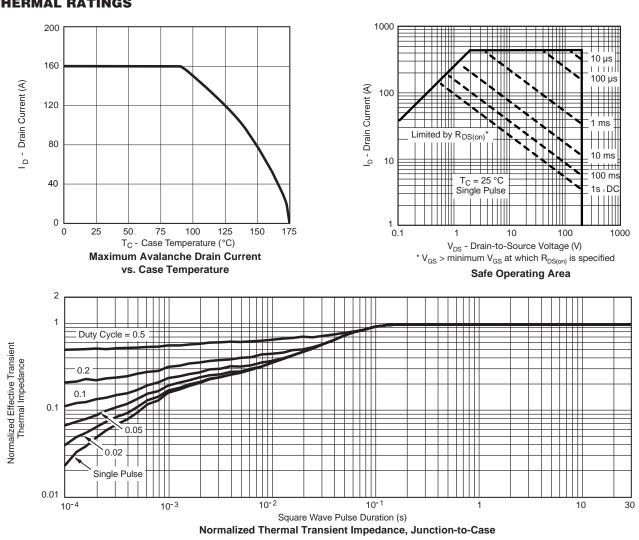
0.9

1.2

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



THERMAL RATINGS



100

10

1

0

0.3

T_J = 150 °C

0.6

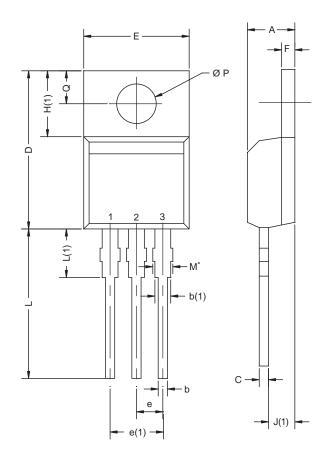
V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

I_S - Source Current (A)



Package Information www.din-tek.jp



TO-220AB

	MILLIN	IETERS	INC	HES			
DIM.	MIN.	MAX.	MIN.	MAX.			
A	4.25	4.65	0.167	0.183			
b	0.69	1.01	0.027	0.040			
b(1)	1.20	1.73	0.047	0.068			
с	0.36	0.61	0.014	0.024			
D	14.85	15.49	0.585	0.610			
E	10.04	10.51	0.395	0.414			
е	2.41	2.67	0.095	0.105			
e(1)	4.88	5.28	0.192	0.208			
F	1.14	1.40	0.045	0.055			
H(1)	6.09	6.48	0.240	0.255			
J(1)	2.41	2.92	0.095	0.115			
L	13.35	14.02	0.526	0.552			
L(1)	3.32	3.82	0.131	0.150			
ØP	3.54	3.94	0.139	0.155			
Q	2.60	3.00	0.102	0.118			
	ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471						

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

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